



DMT6011LSS

### **Product Summary**

BV <sub>DSS</sub>	Rds(on) Max	I <sub>D</sub> Max T₄ = +25°C
60V	11mΩ @ V <sub>GS</sub> = 10V	10.6A
	14.5mΩ @ V <sub>GS</sub> = 4.5V	9.5A

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDs(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- High Frequency Switching
- Synchronous Rectification
- DC-DC Converters

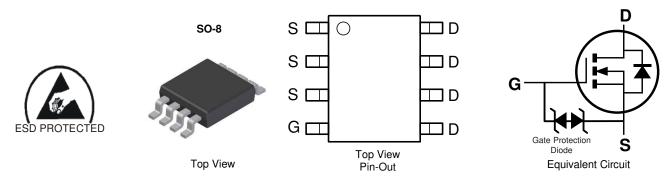
# 60V N-CHANNEL ENHANCEMENT MODE MOSFET

### **Features and Benefits**

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (©3)
- Weight: 0.074 grams (Approximate)



#### Ordering Information (Note 4)

Part Number	Case	Packaging
DMT6011LSS-13	SO-8	2,500/Tape & Reel

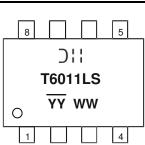
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



SO-8



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Note 6) $V_{GS}$ = 10V	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	10.6 8.5	А
Maximum Continuous Body Diode Forward Current (Note	ls	2.1	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	85	A	
Pulsed Body Diode Forward Current (10µs Pulse, Duty C	Ism	85	A	
Avalanche Current, L = 0.3mH	las	16.2	А	
Avalanche Energy, L = 0.3mH	E <sub>AS</sub>	39.4	mJ	

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	TA = +25°C	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	89.2	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 6) Steady State		Reja	58.3	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	7.7	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

# Electrical Characteristics (T<sub>A</sub> = +25°C, unless otherwise specified.)

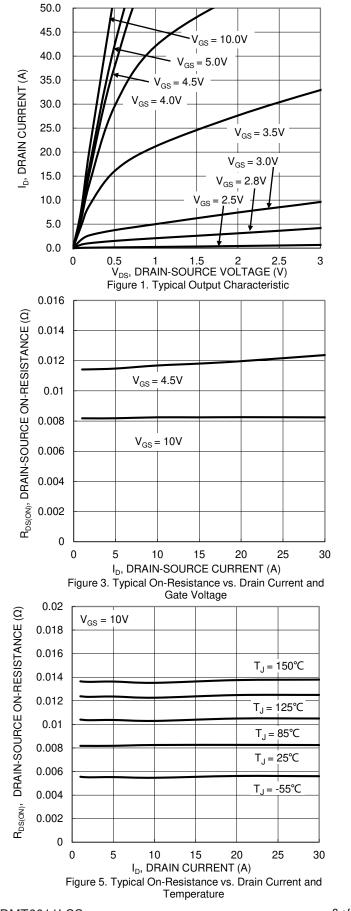
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						÷
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	—	_	V	$V_{GS} = 0V$ , $I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS	_	—	1	μA	$V_{DS} = 48V$ , $V_{GS} = 0V$
Gate-Source Leakage	Igss	_	—	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	VGS(TH)	1.4	—	2.5	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
		_	8.1	11	mΩ	VGS = 10V, ID = 10A
Static Drain-Source On-Resistance	RDS(ON)		11.5	14.5		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5A
Diode Forward Voltage	V <sub>SD</sub>		0.7	1.2	V	$V_{GS} = 0V$ , $I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						·
Input Capacitance	Ciss	_	1072	_		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz
Output Capacitance	Coss		382	_	pF	
Reverse Transfer Capacitance	Crss	_	38	_		
Gate Resistance	Rg	_	1.4	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	11.8	_		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	22.2	—		V <sub>DS</sub> = 30V, I <sub>D</sub> = 10A
Gate-Source Charge	Qgs	—	3.8	—	nC	
Gate-Drain Charge	Q <sub>gd</sub>	_	5.0	_		
Turn-On Delay Time	tD(ON)	_	8.2	_		$\label{eq:VGS} \begin{split} V_{GS} &= 10V,  V_{DS} = 30V, \\ R_G &= 6\Omega,  I_D = 10A \end{split}$
Turn-On Rise Time	tR	_	3.9	_		
Turn-Off Delay Time	tD(OFF)		21.2	_	ns	
Turn-Off Fall Time	tF	_	15.7	_		
Body Diode Reverse Recovery Time	trr		30.6	_	ns	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	21.9	_	nC	$I_F = 10A$ , di/dt = 100A/µs

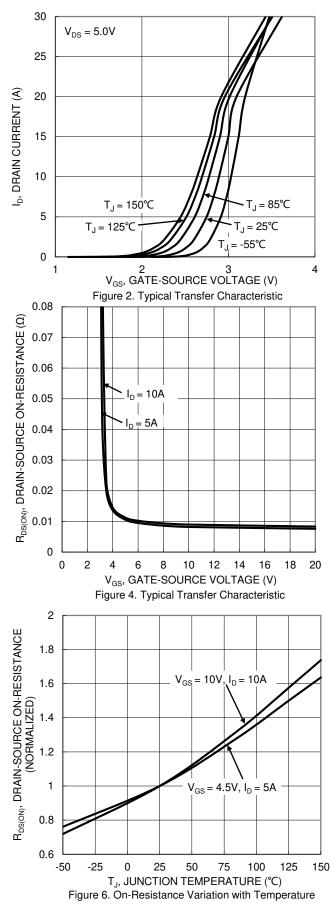
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect. Notes:

8. Guaranteed by design. Not subject to product testing.



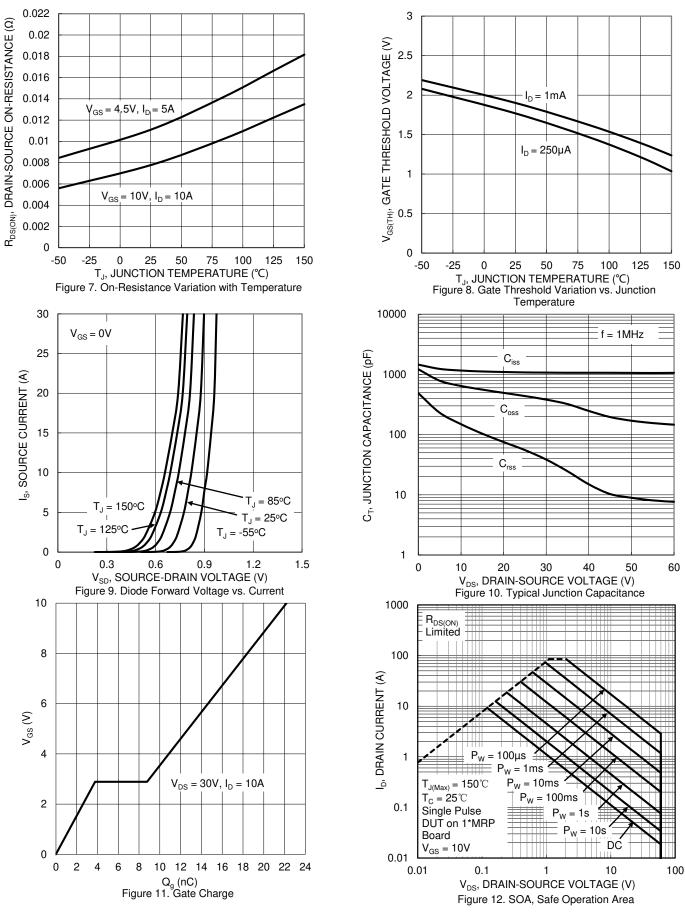
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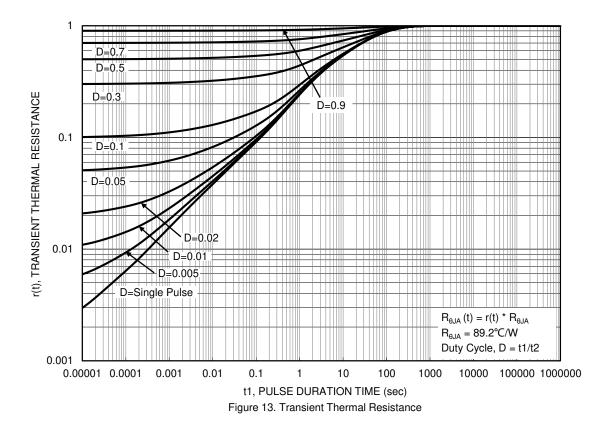
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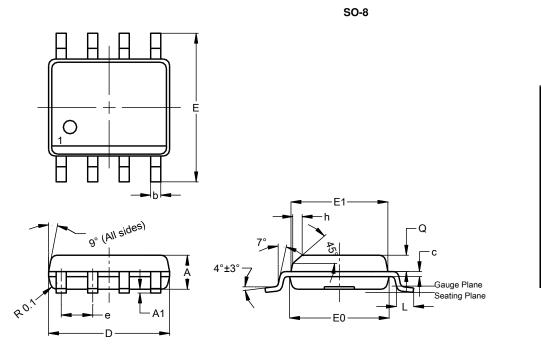






## **Package Outline Dimensions**

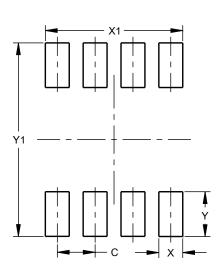
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
С	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е			1.27			
h			0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			

SO-8



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